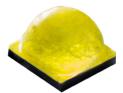
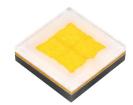


XLamp[®] XHP35.2 Pro9[™] LEDs







XHP35.2 High-Intensity Pro9 LED

PRODUCT DESCRIPTION

The XLamp® XHP35.2 Pro9™ LED is the · Available in 3-step & 2-step EasyWhite® next generation of Extreme High Power LEDs available in the XP footprint. Built . on Cree LED's latest high-power LED . array technology, the XHP35.2 Pro9 LED . improves the voltage characteristics, · efficacy and reliability of the XHP35 LED . in the same 3.45 mm x 3.45 mm footprint. The new XHP35.2 Pro9 LED provides • an easy drop-in upgrade so that lighting . manufacturers can achieve higher system . LPW on existing XHP35 designs with minimal system redesign cost.

The XHP35.2 Pro9 LED offers a high-intensity option. In this document, the term XHP35.2 Pro9 denotes the XHP35.2 Pro9 LED without regard to high density or high intensity. The terms High Density and High Intensity are used when necessary to differentiate the performance of the two options.

FEATURES

- bins at 2700 K-4000 K CCT
- Available in 90- & 95-CRI minimum
- Binned at 85 °C
- Maximum drive current: 700 mA
- Low thermal resistance: 0.7 °C/W
- Wide viewing angle High Density: 130°, High Intensity: 120°
- Unlimited floor life at ≤ 30 °C/85% RH
- Reflow solderable JEDEC J-STD-020C
- RoHS and REACH compliant

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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		0.7	
Viewing angle (FWHM) - High Density	degrees		130	
Viewing angle (FWHM) - High Intensity	degrees		120	
Temperature coefficient of voltage	mV/°C		-5	
ESD withstand voltage (HBM per Mil-Std-883D)			Class 3B	
DC forward current	mA			700
Reverse voltage	V			1
Forward voltage (@ 350 mA, 85 °C)	V		11.2	12.2
LED junction temperature	°C			150

Note

• Thermal resistance measurement was performed per the JEDEC JESD51-14 standard. See the Thermal Resistance Measurement application note for more details.



FLUX CHARACTERISTICS, ORDER CODES & BINS - HIGH-DENSITY PRO9™ (I_F = 350 mA, T_J = 85 °C)

The following table provides order codes for XLamp XHP35.2 High-Density Pro9 LEDs. For a complete description of how the flux and chromaticity groups are reflected in the bin code and order code nomenclature, please see the Bin and Order Code Formats section (page 13).

Nominal	С	RI	Minimum		2-Step		3-Step			
CCT	Min.	Тур	Luminous Flux (lm)	Group	Order Code	Group	Order Code			
	90 92		00 65		510	40H	XHP35B-00-0000-0DPUD240H	40G	XHP35B-00-0000-0DPUD240G	
	90	92	475	40H	XHP35B-00-0000-0DPUC440H	40G	XHP35B-00-0000-0DPUC440G			
4000 K			475	40H	XHP35B-00-0000-0DPZC440H	40G	XHP35B-00-0000-0DPZC440G			
	95	98	440	40H	XHP35B-00-0000-0DPZC240H	40G	XHP35B-00-0000-0DPZC240G			
			410	40H	XHP35B-00-0000-0DPZB440H	40G	XHP35B-00-0000-0DPZB440G			
	90	92	510	35H	XHP35B-00-0000-0DPUD235H	35G	XHP35B-00-0000-0DPUD235G			
	90	90	90	90	92	475	35H	XHP35B-00-0000-0DPUC435H	35G	XHP35B-00-0000-0DPUC435G
3500 K			475	35H	XHP35B-00-0000-0DPZC435H	35G	XHP35B-00-0000-0DPZC435G			
	95	98	440	35H	XHP35B-00-0000-0DPZC235H	35G	XHP35B-00-0000-0DPZC235G			
					410	35H	XHP35B-00-0000-0DPZB435H	35G	XHP35B-00-0000-0DPZB435G	
	90 92		475	30H	XHP35B-00-0000-0DPUC430H	30G	XHP35B-00-0000-0DPUC430G			
3000 K	90	92	440	30H	XHP35B-00-0000-0DPUC230H	30G	XHP35B-00-0000-0DPUC230G			
3000 K	95	98	440	30H	XHP35B-00-0000-0DPZC230H	30G	XHP35B-00-0000-0DPZC230G			
	95 98		410	30H	XHP35B-00-0000-0DPZB430H	30G	XHP35B-00-0000-0DPZB430G			
	90 92		440	27H	XHP35B-00-0000-0DPUC227H	27G	XHP35B-00-0000-0DPUC227G			
2700 K	90	92	410	27H	XHP35B-00-0000-0DPUB427H	27G	XHP35B-00-0000-0DPUB427G			
2700 K	95	98	410	27H	XHP35B-00-0000-0DPZB427H	27G	XHP35B-00-0000-0DPZB427G			
	90	90 98	380	27H	XHP35B-00-0000-0DPZB227H	27G	XHP35B-00-0000-0DPZB227G			

Notes:

- Cree LED maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 15).
- XLamp XHP35.2 Pro9 LED order codes specify only a minimum flux bin and not a maximum. Cree LED may ship reels in flux bins higher than the
 minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity bin restrictions specified by the order
 code.



FLUX CHARACTERISTICS, ORDER CODES & BINS - HIGH-INTENSITY PRO9™ (I_F = 350 mA, T_J = 85 °C)

The following table provides order codes for XLamp XHP35.2 High-Intensity Pro9 LEDs. For a complete description of how the flux and chromaticity groups are reflected in the bin code and order code nomenclature, please see the Bin and Order Code Formats section (page 13).

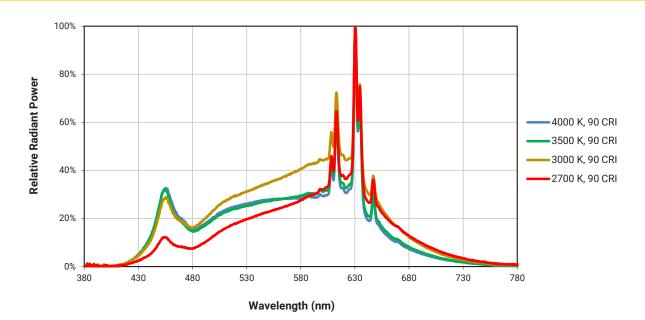
Nominal	CRI		Minimum		2-Step		3-Step		
ССТ	Min.	Тур	Luminous Flux (lm)	Group Order Code		Group	Order Code		
	00	00	440	40H	XHP35B-H0-0000-0DPUC240H	40G	XHP35B-H0-0000-0DPUC240G		
4000 K	90	92	410	40H	XHP35B-H0-0000-0DPUB440H	40G	XHP35B-H0-0000-0DPUB440G		
4000 K	95	98	380	40H	XHP35B-H0-0000-0DPZB240H	40G	XHP35B-H0-0000-0DPZB240G		
	90	90	355	40H	XHP35B-H0-0000-0DPZA440H	40G	XHP35B-H0-0000-0DPZA440G		
	00	92	440	35H	XHP35B-H0-0000-0DPUC235H	35G	XHP35B-H0-0000-0DPUC235G		
3500 K	90	90	90	92	410	35H	XHP35B-H0-0000-0DPUB435H	35G	XHP35B-H0-0000-0DPUB435G
3500 K	0.5	98	380	35H	XHP35B-H0-0000-0DPZB235H	35G	XHP35B-H0-0000-0DPZB235G		
	95	98	355	35H	XHP35B-H0-0000-0DPZA435H	35G	XHP35B-H0-0000-0DPZA435G		
	90	92	440	30H	XHP35B-H0-0000-0DPUC230H	30G	XHP35B-H0-0000-0DPUC230G		
3000 K	90	92	410	30H	XHP35B-H0-0000-0DPUB430H	30G	XHP35B-H0-0000-0DPUB430G		
3000 K	٥٢	98	380	30H	XHP35B-H0-0000-0DPZB230H	30G	XHP35B-H0-0000-0DPZB230G		
	95		95	98	355	30H	XHP35B-H0-0000-0DPZA430H	30G	XHP35B-H0-0000-0DPZA430G
	00	00	410	27H	XHP35B-H0-0000-0DPUB427H	27G	XHP35B-H0-0000-0DPUB427G		
0700 1/	90	92	380	27H	XHP35B-H0-0000-0DPUB227H	27G	XHP35B-H0-0000-0DPUB227G		
2700 K	٥٢	00	380	27H	XHP35B-H0-0000-0DPZB227H	27G	XHP35B-H0-0000-0DPZB227G		
	95	98	355	27H	XHP35B-H0-0000-0DPZA427H	27G	XHP35B-H0-0000-0DPZA427G		

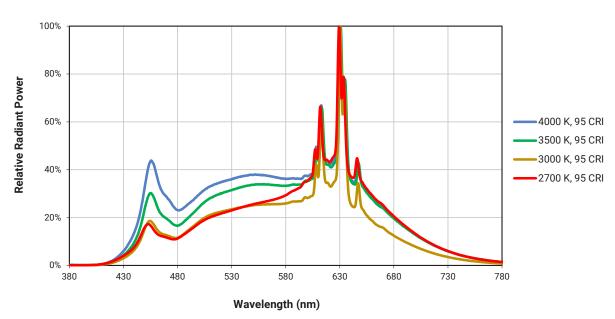
Notes:

- Cree LED maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 15).
- XLamp XHP35.2 Pro9 LED order codes specify only a minimum flux bin and not a maximum. Cree LED may ship reels in flux bins higher than the
 minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity bin restrictions specified by the order
 code.



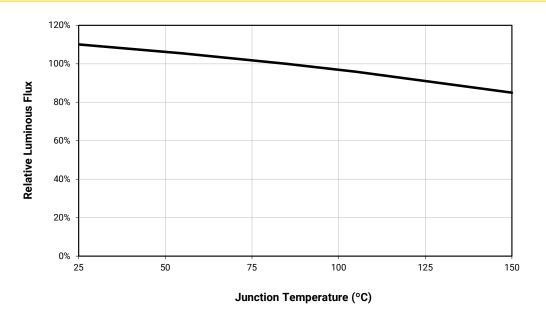
RELATIVE SPECTRAL POWER DISTRIBUTION



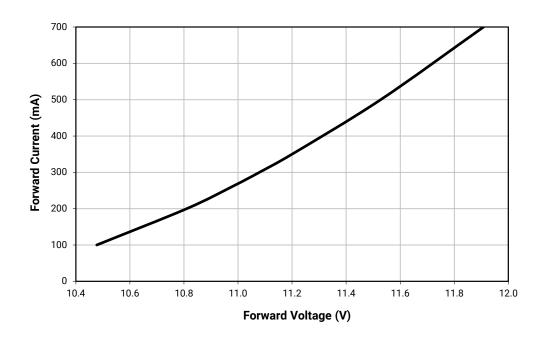




RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)

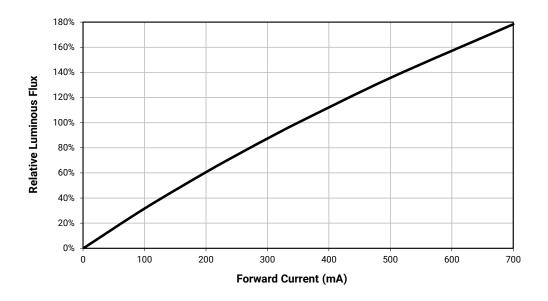


ELECTRICAL CHARACTERISTICS (T_J = 85 °C)



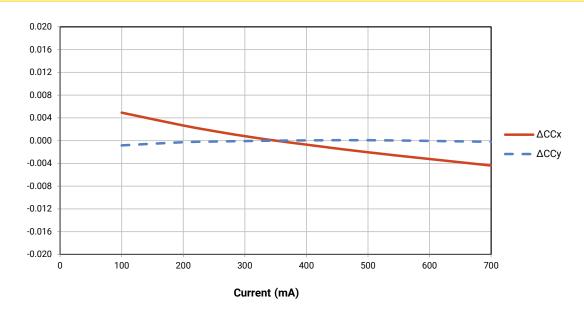


RELATIVE FLUX VS. CURRENT ($T_J = 85$ °C)

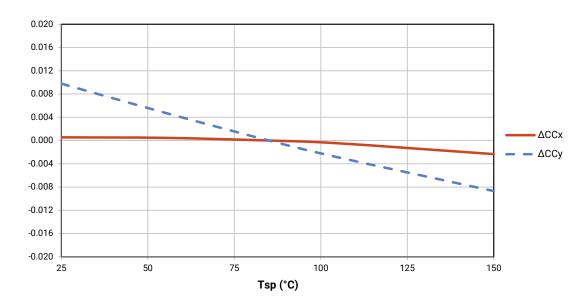




RELATIVE CHROMATICITY VS. CURRENT (WARM WHITE)

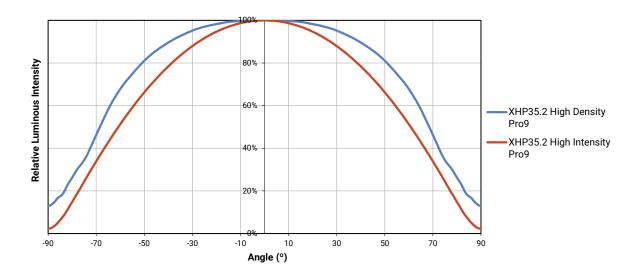


RELATIVE CHROMATICITY VS. TEMPERATURE (WARM WHITE)



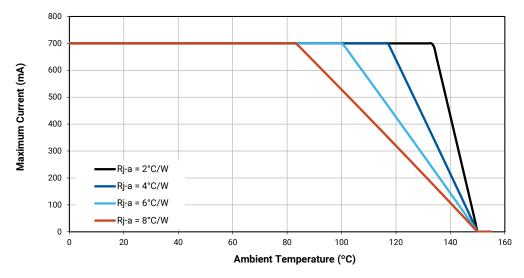


TYPICAL SPATIAL DISTRIBUTION



THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.





PERFORMANCE GROUPS - LUMINOUS FLUX (T $_{\! \scriptscriptstyle J}$ = 85 $^{\circ}\text{C})$

XLamp XHP35.2 Pro9 LEDs are tested for luminous flux and placed into one of the following luminous-flux groups.

Group Code	Minimum Luminous Flux (lm) @ 350 mA	Maximum Luminous Flux (lm) @ 350 mA
A4	355	380
B2	380	410
B4	410	440
C2	440	475
C4	475	510
D2	510	550
D4	550	590



PERFORMANCE GROUPS - CHROMATICITY

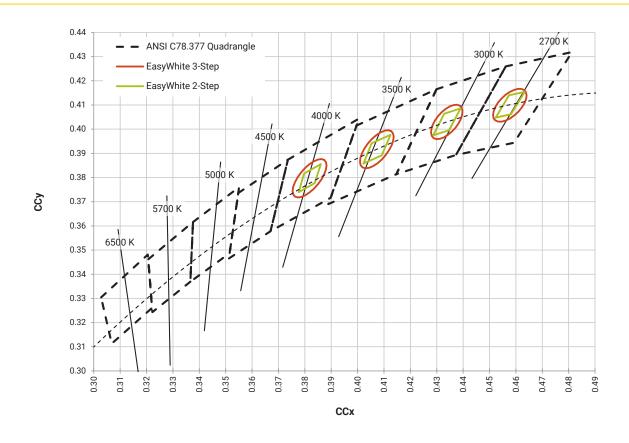
XLamp XHP35.2 Pro9 LEDs are tested for chromaticity and placed into one of the regions defined by the following bounding coordinates.

EasyWhite Color Temperatures - 2-Step									
Bin Code	сст	х	у						
		0.3777	0.3739						
40H	4000 K	0.3797	0.3816						
40H	4000 K	0.3861	0.3855						
		0.3838	0.3777						
		0.4022	0.3858						
35H	3500 K	0.4053	0.3942						
3311		0.4125	0.3977						
		0.4091	0.3891						
		0.4287	0.3975						
30H	00001/	0.4328	0.4064						
3011	3000 K	0.4390	0.4086						
		0.4347	0.3996						
		0.4524	0.4048						
27H	2700 K	0.4574	0.4140						
2/П	2700 K	0.4633	0.4154						
		0.4581	0.4062						

	EasyWhite Color Temperatures - 3-Step Ellipse										
Bin Code	сст	Cente	r Point	Major Axis	Minor Axis	Rotation Angle					
Bill Code	001	х	у	а	b	(°)					
40G	4000 K	0.3818	0.3797	0.00939	0.00402	53.7					
35G	3500 K	0.4073	0.3917	0.00927	0.00414	54.0					
30G	3000 K	0.4338	0.4030	0.00834	0.00408	53.2					
27G	2700 K	0.4577	0.4099	0.00834	0.00420	48.5					



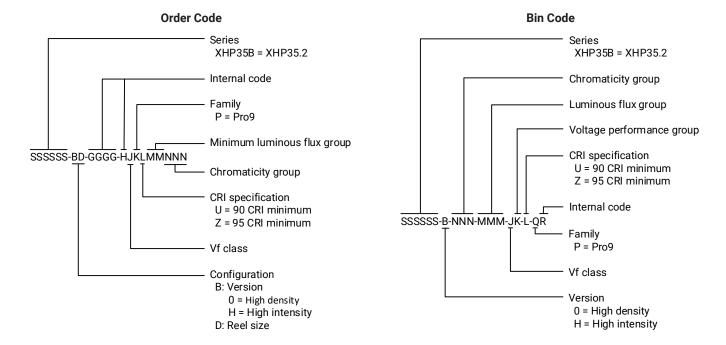
EASYWHITE® CHROMATICITY REGIONS PLOTTED ON THE 1931 CIE CURVE





BIN AND ORDER CODE FORMATS

Bin codes and order codes for XHP35.2 Pro9 LEDs are configured in the following manner:

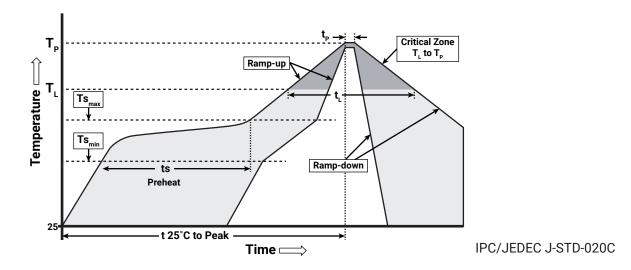




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree LED has found XLamp XHP35.2 Pro9 LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree LED recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer's responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Free Solder
Average Ramp-Up Rate $(Ts_{max} to T_p)$	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t _L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.



NOTES

LED Use

Use of this LED in information displays utilizing LCD Backlights and other emissive pixel display technology is prohibited ("Use Restrictions").

Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree LED's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree LED applies to ensure long-term reliability for XLamp LEDs and details of Cree LED's pre-release qualification testing for XLamp LEDs.

Lumen Maintenance

Cree LED now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree LED's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree LED recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XHP35.2 Pro9 LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of \leq 30 °C/85% relative humidity (RH). Regardless of the storage condition, Cree LED recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

REACH Compliance

REACH substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree LED



NOTES - CONTINUED

representative to insure you get the most up-to-date REACH SVHC Declaration. REACH banned substance information (REACH Article 67) is also available upon request.

Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

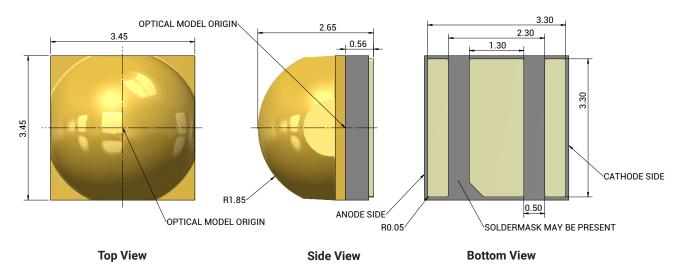


MECHANICAL DIMENSIONS

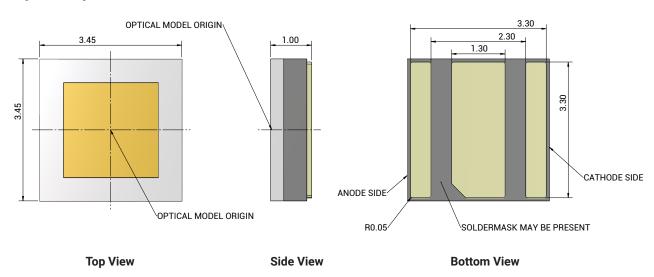
Thermal vias, if present, are not shown on these drawings.

All dimensions are ±.13 mm unless otherwise indicated.

XHP35.2 High-Density Pro9



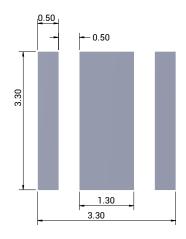
XHP35.2 High-Intensity Pro9

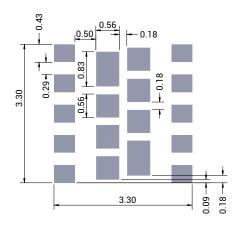




MECHANICAL DIMENSIONS - CONTINUED

XHP35.2 High-Density Pro9 and XHP35.2 High-Intensity Pro9





Recommended PCB Footprint

Recommended Stencil Openings*

Notes:

- Cree LED recommends using thermal pad kickouts to maximize component thermal performance.
- Cree LED recommends using white solder mask material to minimize system optical loss.
- * This stencil has been tested and optimized for the avoidance of voiding when using ALPHA® LUMET® P30 Maxrel solder paste. For other solder pastes, a "window pane" design for the thermal pad stencil may result in a lower voiding percentage. Contact your local Cree LED Field Applications Engineer for consultation regarding your specific application.



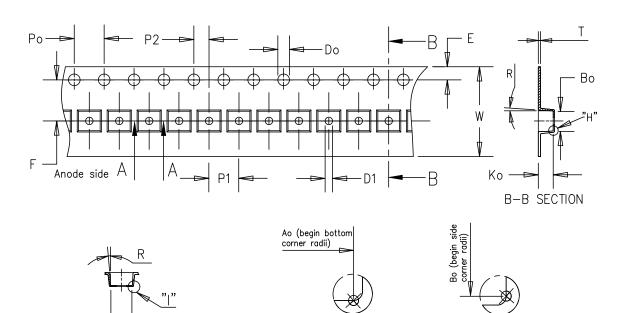
TAPE AND REEL

All Cree LED carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Except as noted, all dimensions in mm [inches]

All dimensions are ±.15 mm unless otherwise indicated.

DETAIL"H"



XHP35.2 High-Density Pro9



A-A SECTION

Item	Ao	Во	Ko	Ро	P1	P2	Т	Е	F	Do	D1	W	R
Dimension	3.60	3.60	3.00	4.00	8.00	2.00	0.30	1.75	5.50	1.50	1.50	12.00	3°

DETAIL"I"

XHP35.2 High-Intensity Pro9



Item	Ao	Во	Ko	Po	P1	P2	Т	E	F	Do	D1	W	R
Dimension	3.70	3.70	1.20	4.00	8.00	2.00	0.30	1.75	5.50	1.50	1.50	12.00	3°



TAPE AND REEL - CONTINUED

XHP35.2 High-Density Pro9

Trailer

Min. 160 mm empty pockets sealed with tape

Loaded Pockets

500 Lamps

Leader

Min. 400 mm empty pockets with min. 100 mm sealed

Feed Direction



TAPE AND REEL - CONTINUED

XHP35.2 High-Intensity Pro9

Trailer

Min. 160 mm empty pockets sealed with tape

Loaded Pockets

1000 Lamps

Leader

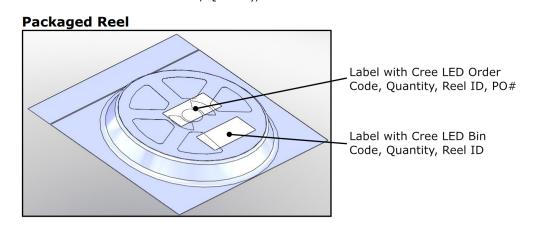
Min. 400 mm empty pockets with min. 100 mm sealed

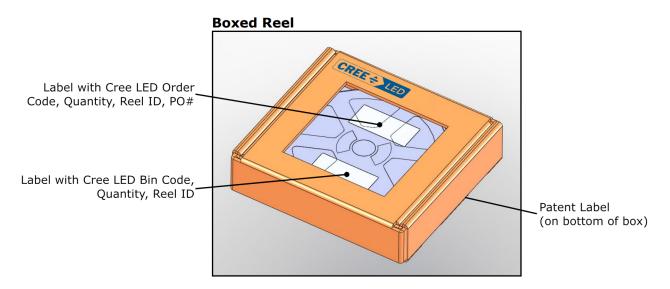
Feed Direction



PACKAGING

Label with Cree LED Bin Code, Quantity, Reel ID





Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Cree LED:

XHP35B-00-0000-0DPUB427G XHP35B-00-0000-0DPUB427H XHP35B-00-0000-0DPUB430G XHP35B-00-0000-0DPUB430H XHP35B-00-0000-0DPUC227G XHP35B-00-0000-0DPUC227H XHP35B-00-0000-0DPUC230G XHP35B-00-0000-0DPUC230H XHP35B-00-0000-0DPUC235G XHP35B-00-0000-0DPUC235H XHP35B-00-0000-0DPUC240G XHP35B-00-0000-0DPUC240H XHP35B-00-0000-0DPUC430G XHP35B-00-0000-0DPUC430H XHP35B-00-0000-0DPUC435G XHP35B-00-0000-0DPUC435H XHP35B-00-0000-0DPUC440G XHP35B-00-0000-0DPUC440H XHP35B-00-0000-0DPUD235G XHP35B-00-0000-0DPUD235H XHP35B-00-0000-0DPUD240G XHP35B-00-0000-0DPUD240H XHP35B-H0-0000-0DPUA427G XHP35B-H0-0000-0DPUA427H XHP35B-H0-0000-0DPUB227G XHP35B-H0-0000-0DPUB227H XHP35B-H0-0000-0DPUB230G XHP35B-H0-0000-0DPUB230H XHP35B-H0-0000-0DPUB427G XHP35B-H0-0000-0DPUB427H XHP35B-H0-0000-0DPUB430G XHP35B-H0-0000-0DPUB430H XHP35B-H0-0000-0DPUB435G XHP35B-H0-0000-0DPUB435H XHP35B-H0-0000-0DPUB440G XHP35B-H0-0000-0DPUB440H XHP35B-H0-0000-0DPUC230G XHP35B-H0-0000-0DPUC230H XHP35B-H0-0000-0DPUC235G XHP35B-H0-0000-0DPUC235H XHP35B-H0-0000-0DPUC240G XHP35B-H0-0000-0DPUC240H XHP35B-00-0000-0DPZB227G XHP35B-00-0000-0DPZB227H XHP35B-00-0000-0DPZB427G XHP35B-00-0000-0DPZB427H XHP35B-00-0000-0DPZB430G XHP35B-00-0000-0DPZB430H XHP35B-00-0000-0DPZB435G XHP35B-00-0000-0DPZB435H XHP35B-00-0000-0DPZB440G XHP35B-00-0000-0DPZB440H XHP35B-00-0000-0DPZC230G XHP35B-00-0000-0DPZC230H XHP35B-00-0000-0DPZC235G XHP35B-00-0000-0DPZC235H XHP35B-00-0000-0DPZC240G XHP35B-00-0000-0DPZC240H XHP35B-00-0000-0DPZC435G XHP35B-00-0000-0DPZC435H XHP35B-00-0000-0DPZC440G XHP35B-00-0000-0DPZC440H XHP35B-H0-0000-0DPZA427G XHP35B-H0-0000-0DPZA427H XHP35B-H0-0000-0DPZA430G XHP35B-H0-0000-0DPZA430H XHP35B-H0-0000-0DPZA435G XHP35B-H0-0000-0DPZA435H XHP35B-H0-0000-0DPZA440G XHP35B-H0-0000-0DPZA440H XHP35B-H0-0000-0DPZB227G XHP35B-H0-0000-0DPZB227H XHP35B-H0-0000-0DPZB230G XHP35B-H0-0000-0DPZB230H XHP35B-H0-0000-0DPZB235G XHP35B-H0-0000-0DPZB235H XHP35B-H0-0000-0DPZB240G XHP35B-H0-0000-0DPZB240H XHP35B-H0-0000-0DPZB435G XHP35B-H0-0000-0DPZB435H XHP35B-H0-0000-0DPZB440G XHP35B-H0-0000-0DPZB440H